

ANTREX Electronics

Electronic Components Sourcing Information

Product Reference Information

Part Number:	B2000T
Manufacturer:	Bourns Inc.
Package:	2-SMD, Square End Block
Availability:	Please confirm with sales

Product Page:

<https://antrexco.com/product/details/bourns-inc/b2000t.html>

Request a Quote:

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Quality & Trust

New & Original Components

Supplier verification and packaging condition review

CoC / RoHS / REACH documents available on request

Secure sourcing support for OEM / EMS projects

Note:

This PDF includes an ANTREX product reference cover page.

The original manufacturer datasheet follows from the next page.



Features

- For use in telecommunication circuit applications requiring low current protection with high surge tolerance
- Overcurrent protection to Telcordia GR-1089-CORE Issue 4 (B1250T only) & UL 1950/60950
- Bourns® TISP® products are recommended for the overvoltage section of the circuit



These models are currently available but not recommended for new designs.

- Agency recognition: File: E198545
- RoHS compliant*

Telefuse™ SMD Power Cross Protection Fuse

Electrical Characteristics

Model Number	Ampere Rating (A)	Voltage Rating (VRMS)	Typical Cold Resistance (Ohms)	Volt-drop @ 100 % In (Volts) Max.	Melting I2T < 10 msec (A2 sec.)	Melting I2T @ 10 In (A2 sec.)	Maximum Power Dissipation (W)
B0500T	0.500	600	0.350	0.23	2	2.3	0.20
B1250T	1.25	600	0.075	0.18	14	17	0.40
B2000T	2.0	600	0.056	0.16	33	37	0.52

Temperature Range

.....-55 °C to +125 °C

Environmental Characteristics

Thermal Shock MIL-STD-202, Method 107, Test Condition B (-65 °C to +125 °C)

Shock..... MIL-STD-202, Method 213, Test Condition I (100 Gs peak for 6 milliseconds)

Vibration MIL-STD-202, Method 201 (10-55 Hz, 0.06 inch total excursion)

Salt Spray ... MIL-STD-202, Method 101, Test Condition B (48 hrs.)

Insulation Resistance MIL-STD-202, Method 302, Test Condition A (after opening) 10,000 ohms minimum

Solderability MIL-STD-202, Method 208

Resistance to Solder Heat MIL-STD-202, Method 210, Test Condition J (235 °C, 30 sec.)

Physical Characteristics

Body Material

..... Ceramic with tin plated brass caps
Solder RoHS 6 Compliant lead free
RoHS reflow compatible;
reference 240 °C, 30 sec. max.

Soldering Process Window

IR Reflow 240 °C for 30 seconds max.
(Not recommended for
Wave solder direct immersion)

Packaging.....2,000 pcs. per 13 " reel

Lightning Surge Withstand Capabilities

Max. Rise/ Min. Decay (μs)	Repetitions		Minimum Peak Voltage (V)	Minimum Withstand Peak Current (A)		
	Total	Each Polarity		B0500T	B1250T	B2000T
10/1000	50	25	1000	25	100	120
10/360	50	25	1000	30	125	150
2/10	20	10	2500	120	500	600
10/360	10	5	1000	30	125	150
2/10	2	1	5000	120	500	600
8/20	2	1	5000	75	300	350

Test Methods per GR-1089/TIA-968-A (FCC Pt. 68)

AC Power Fault Tests

GR-1089 1st Level Test	Voltage (VRMS)	Short Circuit Current (A)	Applications	Duration	Fuse Characteristics		
					B0500T	B1250T	B2000T
1	50	0.33	1	15 min.	Parts pass all 1st Level tests		
2	100	0.17	1	15 min.			
3	200, 400, 600	1	60	1 sec.			
4	1000	1	60	1 sec.			
6	600	0.5	1	30 sec.			
7	440	2.2	5	2 sec.	Will open	Parts pass all 1st Level tests	
8	600	3	5	1.1 sec.	Will open		
9	1000	5	5	0.4 sec.	Will open		

AC Current Limiting Protector Tests/Fusing Coordination Tests

Voltage (Vac)	Current (A)	Duration	Maximum Time for Fuse to Open (Seconds)		
			B0500T	B1250T	B2000T
600	2.2	Up to 15 Min.	1.0	900	Will not open
600	2.6		0.8	50	2000
600	3.0		0.5	10	100
600	3.75		0.3	5	10
600	5		0.2	2	3
600	7		0.08	1	2
600	10		0.04	0.5	0.7
600	12.5		0.01	0.2	0.3
600	20		0.005	0.07	0.1
600	25		0.004	0.04	0.07
600	30		0.003	0.02	0.05

*RoHS Directive 2002/95/EC Jan. 27, 2003 including annex and RoHS Recast 2011/65/EU June 8, 2011.

Specifications are subject to change without notice.

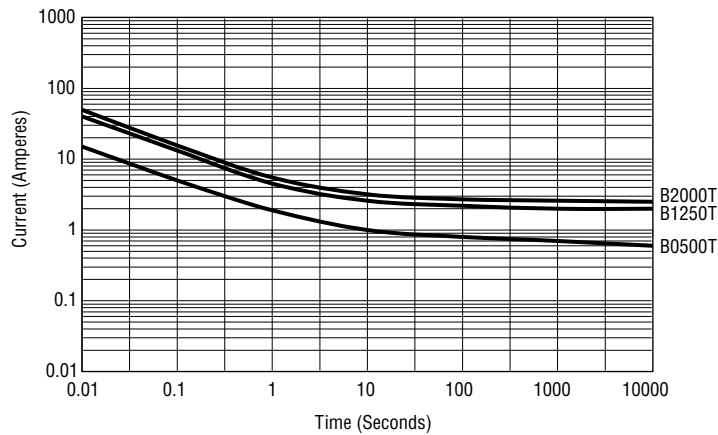
The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time.

Users should verify actual device performance in their specific applications.

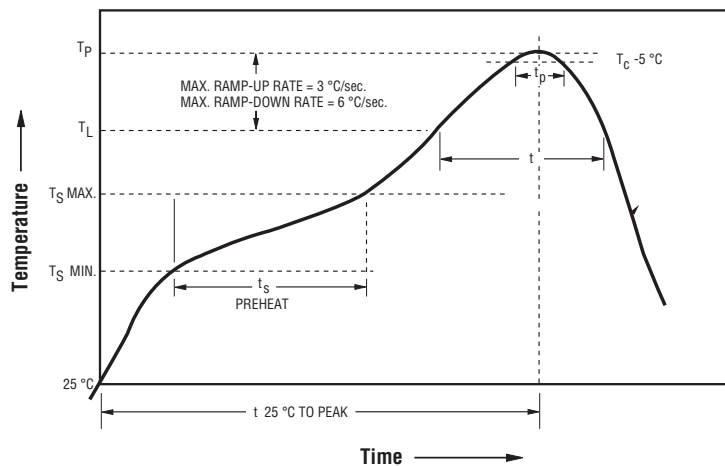
Telefuse™ SMD Power Cross Protection Fuse

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Time/Current Characteristic Curve



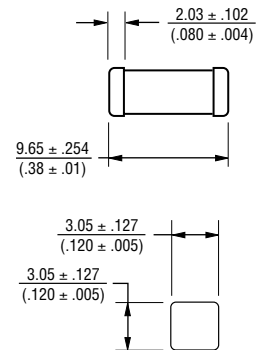
Solder Profile



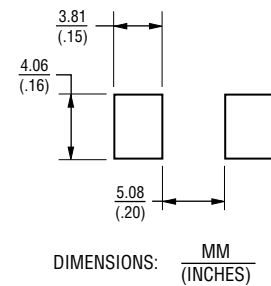
IR Reflow Profile

Reflow Parameter	Value
Minimum Preheat Temperature ($T_{s\text{MIN}}$)	130°C
Maximum Preheat Temperature ($T_{s\text{MAX}}$)	170°C
Preheat Time	60-180 seconds
$T_{s\text{MAX}}$ to T_L Ramp-Up Rate	$3^\circ\text{C} / \text{second max.}$
Time above Temperature T_L (t_L)	200°C for 60-120 seconds
Peak Temperature (T_p)	240°C max.
Time within 5°C of Peak T_p	20-30 seconds
Ramp-Down Rate	$6^\circ\text{C} / \text{second. max.}$

Product Dimensions



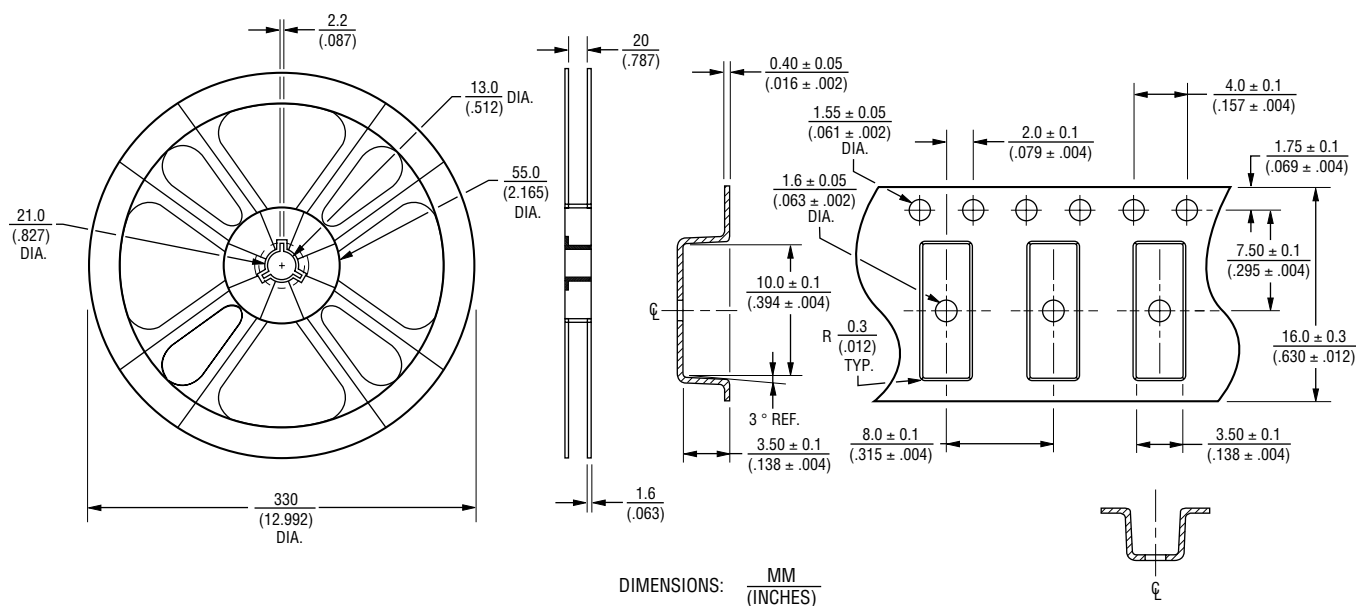
Recommended Pad Layout



Telefuse™ SMD Power Cross Protection Fuse

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Packaging Specifications



REV. 11/16

"Telefuse" is a trademark of Bourns, Inc.

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